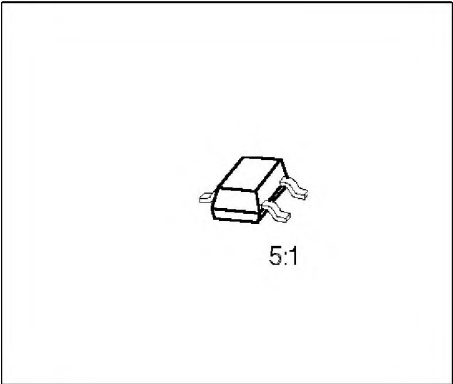


SIPMOS® Small-Signal Transistor

BSS 84

- V_{DS} – 50 V
- I_D – 0.13 A
- $R_{DS(on)}$ 10 Ω
- $V_{GS(th)}$ – 0.8 ... – 1.6 V
- P channel
- Enhancement mode
- Logic level



Type	Ordering Code	Tape and Reel Information	Pin Configuration			Marking	Package
			1	2	3		
BSS 84	Q62702-S568	E6327: 3000 pcs/reel	G	S	D	BSS 84 marked SPs	SOT-23
BSS 84	Q67000-S243	E6433: 10000 pcs/reel					

Maximum Ratings

Parameter	Symbol	Values	Unit
Drain-source voltage	V_{DS}	– 50	V
Drain-gate voltage, $R_{GS} = 20 \text{ k}\Omega$	V_{DGR}	– 50	
Gate-source voltage	V_{GS}	± 20	
Continuous drain current, $T_A = 30 \text{ }^\circ\text{C}$	I_D	– 0.13	A
Pulsed drain current, $T_A = 25 \text{ }^\circ\text{C}$	$I_{D \text{ puls}}$	– 0.52	
Max. power dissipation, $T_A = 25 \text{ }^\circ\text{C}$	P_{tot}	0.36	W
Operating and storage temperature range	T_j, T_{stg}	– 55 ... + 150	$^\circ\text{C}$
Thermal resistance, chip-ambient (without heat sink)	R_{thJA}	≤ 350	K/W
chip-substrate – reverse side ¹⁾	R_{thJSR}	≤ 285	
DIN humidity category, DIN 40 040	–	E	–
IEC climatic category, DIN IEC 68-1	–	55/150/56	

¹⁾ For package mounted on aluminum 15 mm $\times$ 16.7 mm $\times$ 0.7 mm.

Electrical Characteristicsat $T_j = 25\text{ °C}$, unless otherwise specified.

Parameter	Symbol	Values			Unit
		min.	typ.	max.	

Static Characteristics

Drain-source breakdown voltage $V_{GS} = 0, I_D = -0.25\text{ mA}$	$V_{(BR)DSS}$	- 50	-	-	V
Gate threshold voltage $V_{GS} = V_{DS}, I_D = -1\text{ mA}$	$V_{GS(th)}$	- 0.8	- 1.5	- 2.0	
Zero gate voltage drain current $V_{DS} = -50\text{ V}, V_{GS} = 0$ $T_j = 25\text{ °C}$ $T_j = 125\text{ °C}$ $V_{DS} = -25\text{ V}, V_{GS} = 0$ $T_j = 25\text{ °C}$	I_{DSS}	- - -	- 0.1 - 2	- 1.0 - 60 - 0.1	μA
Gate-source leakage current $V_{GS} = -20\text{ V}, V_{DS} = 0$	I_{GSS}	-	- 1	- 10	nA
Drain-source on-resistance $V_{GS} = -10\text{ V}, I_D = -0.13\text{ A}$	$R_{DS(on)}$	-	5.0	10	Ω

Dynamic Characteristics

Forward transconductance $V_{DS} \geq 2 \times I_D \times R_{DS(on)max}, I_D = -0.13\text{ A}$	g_{fs}	0.05	0.085	-	S
Input capacitance $V_{GS} = 0, V_{DS} = -25\text{ V}, f = 1\text{ MHz}$	C_{iss}	-	30	40	pF
Output capacitance $V_{GS} = 0, V_{DS} = -25\text{ V}, f = 1\text{ MHz}$	C_{oss}	-	17	25	
Reverse transfer capacitance $V_{GS} = 0, V_{DS} = -25\text{ V}, f = 1\text{ MHz}$	C_{rss}	-	8	12	
Turn-on time $t_{on}, (t_{on} = t_{d(on)} + t_r)$ $V_{DD} = -30\text{ V}, V_{GS} = -10\text{ V}, R_{GS} = 50\text{ Ω},$ $I_D = -0.27\text{ A}$	$t_{d(on)}$	-	7	10	ns
	t_r	-	12	18	
Turn-off time $t_{off}, (t_{off} = t_{d(off)} + t_f)$ $V_{DD} = -30\text{ V}, V_{GS} = -10\text{ V}, R_{GS} = 50\text{ Ω},$ $I_D = -0.27\text{ A}$	$t_{d(off)}$	-	10	13	
	t_f	-	20	27	

Electrical Characteristics (cont'd)
at $T_j = 25\text{ }^{\circ}\text{C}$, unless otherwise specified.

Parameter	Symbol	Values			Unit
		min.	typ.	max.	

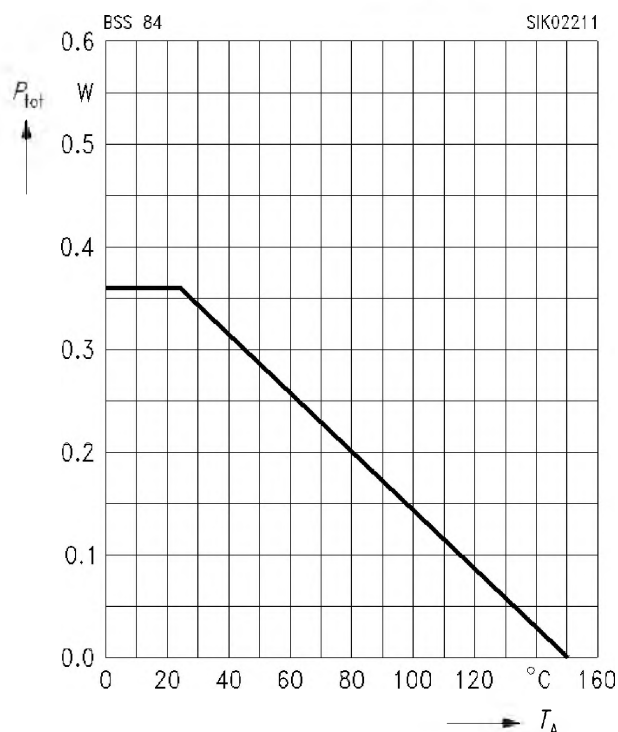
Reverse Diode

Continuous reverse drain current $T_A = 25\text{ }^{\circ}\text{C}$	I_S	—	—	— 0.13	A
Pulsed reverse drain current $T_A = 25\text{ }^{\circ}\text{C}$	I_{SM}	—	—	— 0.52	
Diode forward on-voltage $I_F = -0.26\text{ A}$, $V_{GS} = 0$	V_{SD}	—	— 0.9	— 1.2	V

Characteristics

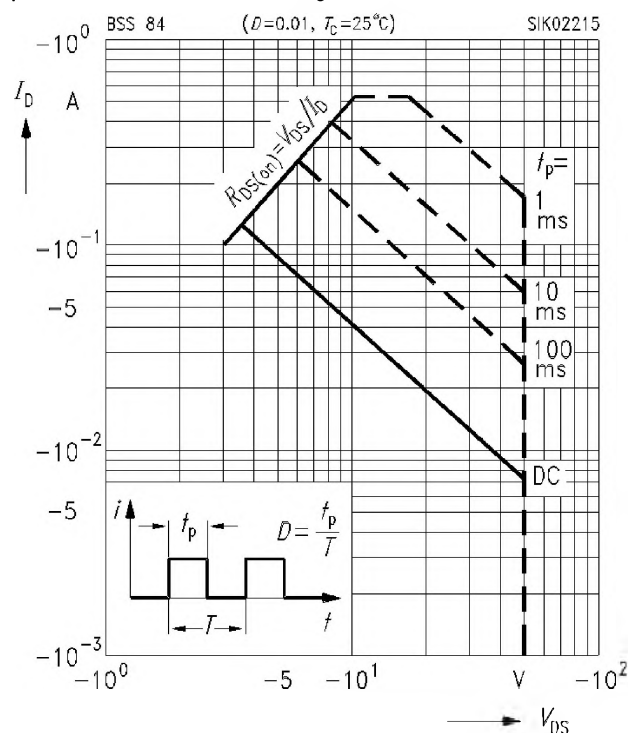
at $T_J = 25^\circ\text{C}$, unless otherwise specified.

Total power dissipation $P_{\text{tot}} = f(T_A)$



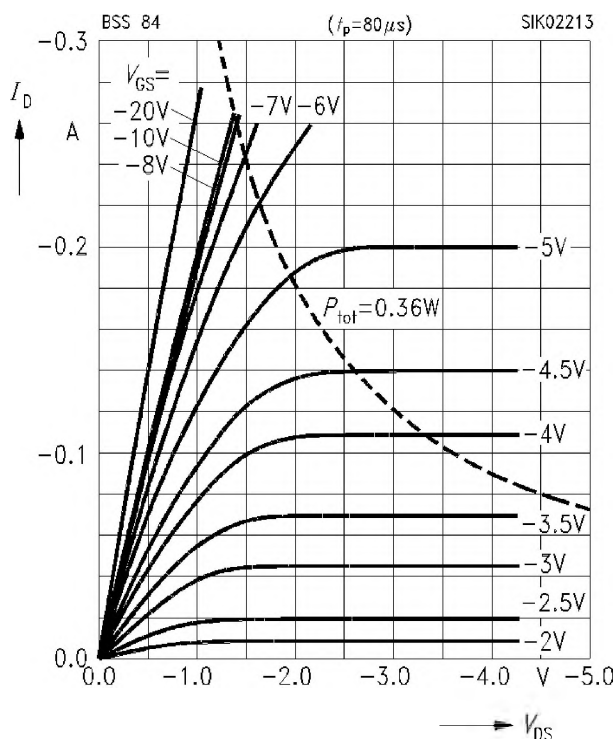
Safe operating area $I_D = f(V_{\text{DS}})$

parameter: $D = 0.01$, $T_C = 25^\circ\text{C}$



Typ. output characteristics $I_D = f(V_{\text{DS}})$

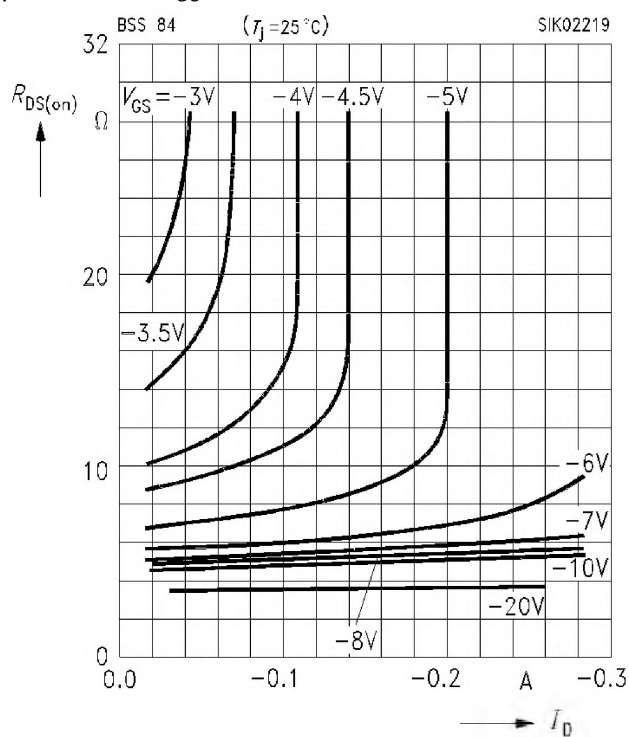
parameter: $t_p = 80 \mu\text{s}$



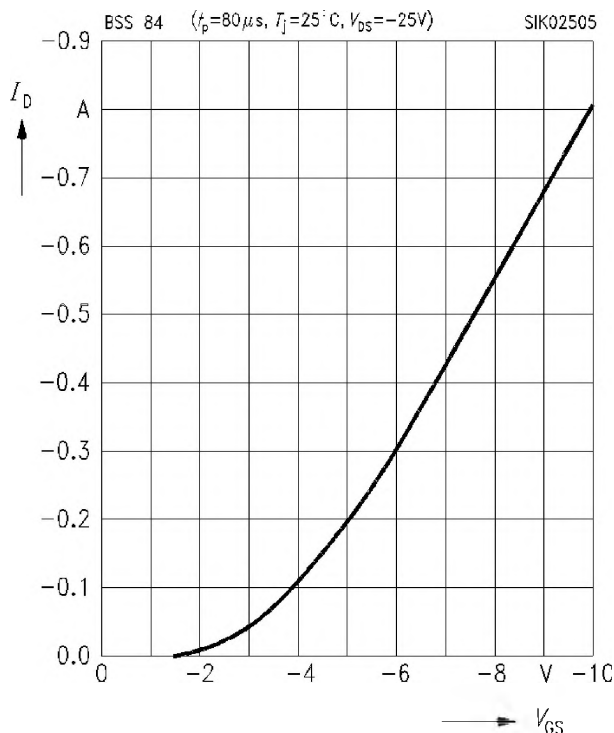
Typ. drain-source on-resistance

$R_{\text{DS(on)}} = f(I_D)$

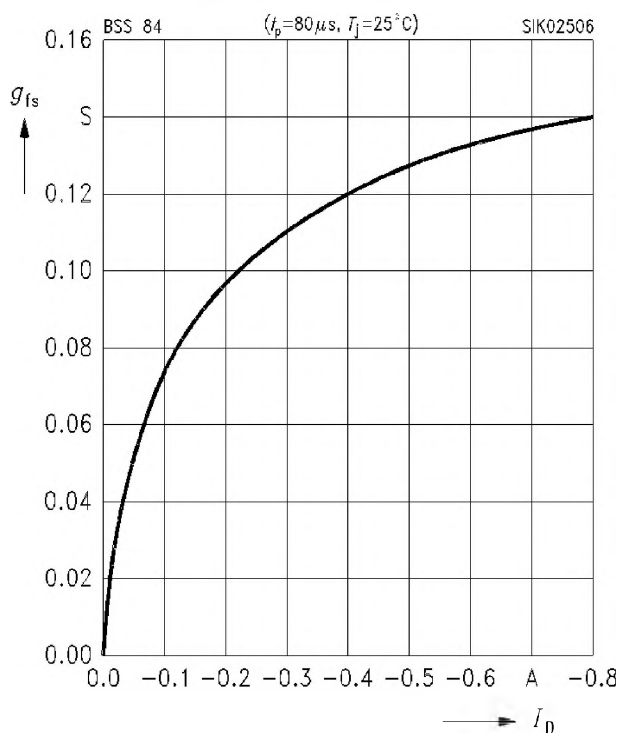
parameter: V_{GS}



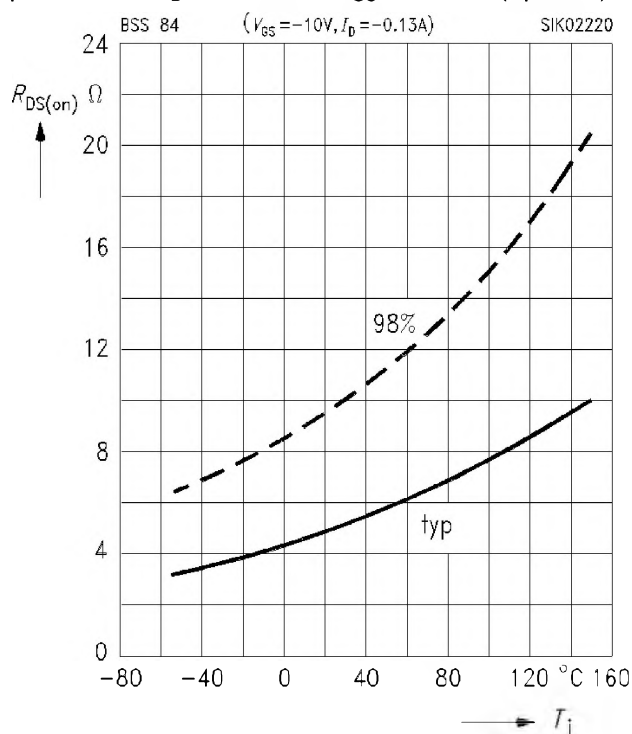
Typ. transfer characteristics $I_D = f(V_{GS})$
 parameter: $t_p = 80 \mu s$, $V_{DS} \geq 2 \times I_D \times R_{DS(on)max.}$



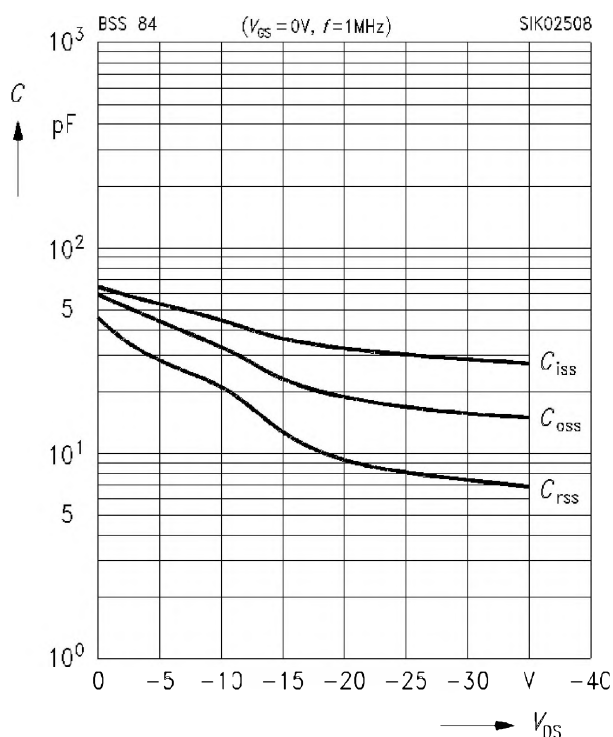
Typ. forward transconductance $g_{fs} = f(I_D)$
 parameter: $V_{DS} \geq 2 \times I_D \times R_{DS(on)max.}$, $t_p = 80 \mu s$



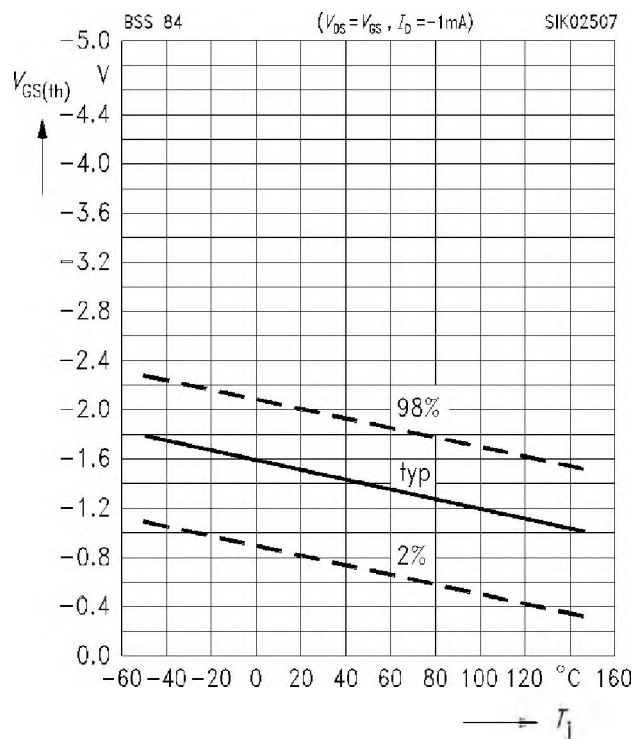
Drain-source on-resistance
 $R_{DS(on)} = f(T_j)$
 parameter: $I_D = -0.13 A$, $V_{GS} = -10 V$, (spread)



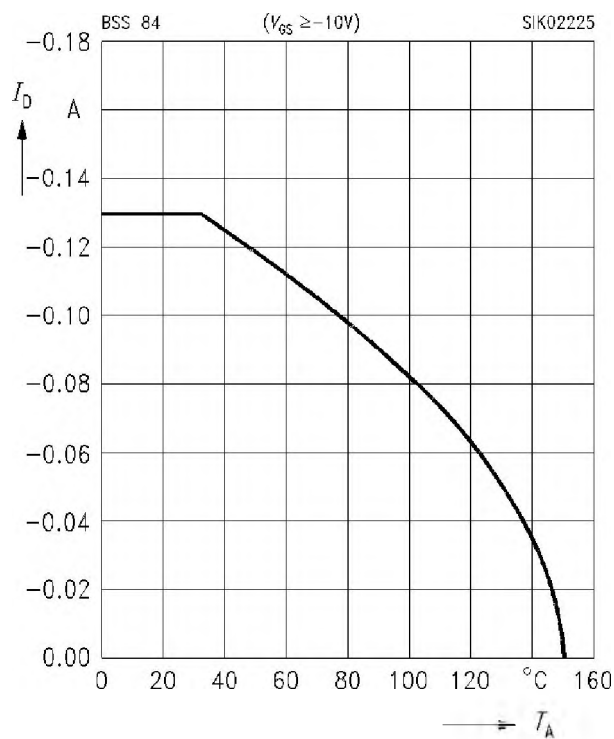
Typ. capacitances $C = f(V_{DS})$
 parameter: $V_{GS} = 0 V$, $f = 1 MHz$



Gate threshold voltage $V_{GS(th)} = f(T_J)$
parameter: $V_{DS} = V_{GS}$, $I_D = -1 \text{ mA}$, (spread)



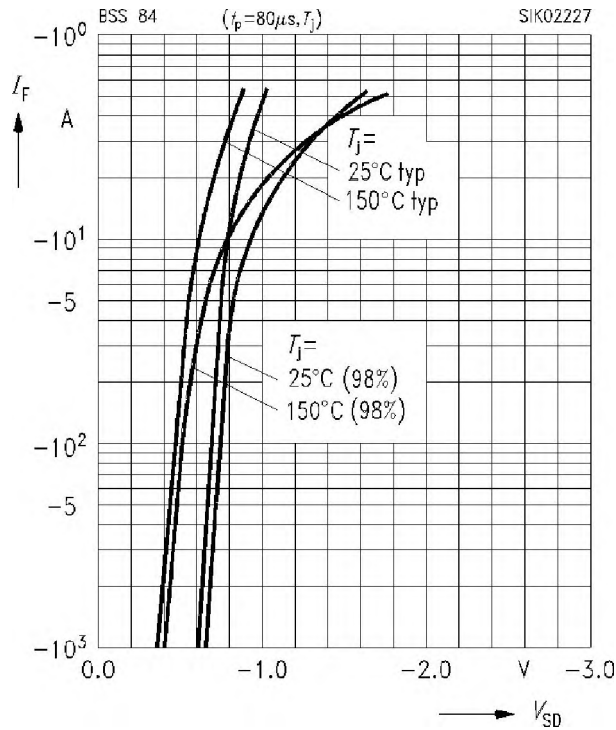
Drain current $I_D = f(T_A)$
parameter: $V_{GS} \geq -10 \text{ V}$



Forward characteristics of reverse diode

$$I_F = f(V_{SD})$$

parameter: $t_p = 80 \mu s$, T_j , (spread)



Drain-source breakdown voltage

$$V_{(BR)DSS} = b \times V_{(BR)DSS} (25^\circ\text{C})$$

